深圳市诚皓光电有限公司

Shenzhen ChengHao Optoelectronic Co., Ltd.

SPECIFICATION

Product Model: CH430WV15A-CT

Designed by	R&D Checked by	Quality Department by	Approved by

Approval by Customer

OK NG,Problem survey:

Approved By _____

Revision Record

REV NO.	REV DATE	CONTENTS	Note
V0	2018-11-15	NEW ISSUE	

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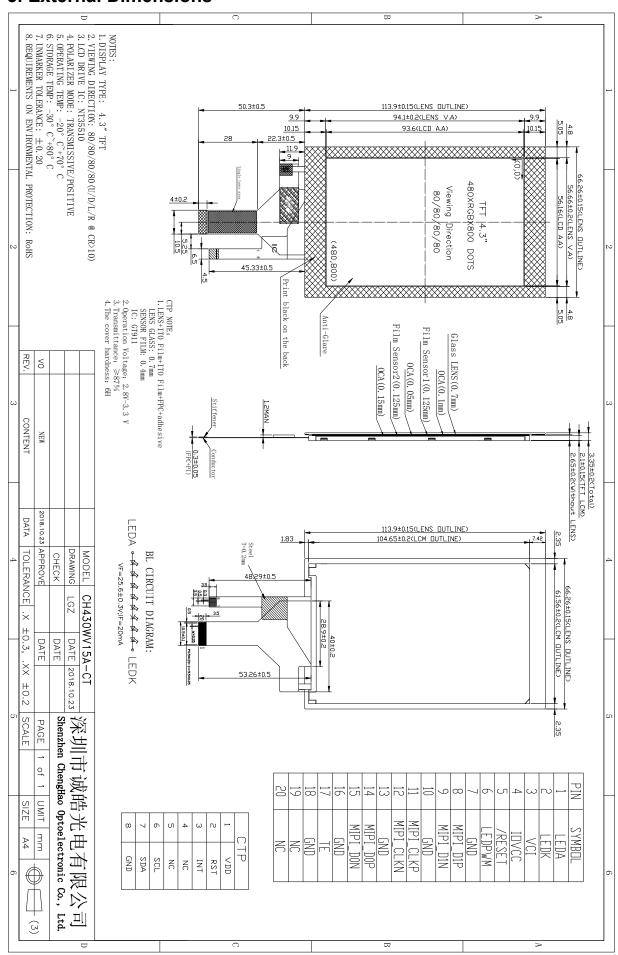
1. Numbering System

TBD

2. TFT General Information

ITEM	STANDARD VALUES	UNITS
LCD type	4.3"TFT + CTP	
Dot arrangement	480×(RGB)×800	dots
Color filter array	RGB vertical stripe	
Display mode	IPS / Transmissive / Normally Black	
Viewing Direction	ALL	
TFT Driver IC	NT35510	
CTP type	G+F+F	
Surface Treatment	6H	
CTP Driver IC	GT911	
Module size	66.26(W)×113.9(H)×3.35(T)	mm
TFT/CTP Active area	56.16(W)×93.6(H)	mm
Dot pitch	0.117(W)×0.117(H)	mm
Interface	2 lane-MIPI DSI	
Operating temperature	-20 ~ +70	C
Storage temperature	-30 ~ +80	C
Back Light	8 White LED in serial	
Weight	TBD	g

3. External Dimensions



4. Interface Description 4.1 TFT Interface Description

Pin NO.	SYMBOL	DESCRIPTION			
1	LEDA	Power for LED backlight (Anode).			
2	LEDK	Power for LED backlight (Cathode).			
3	VCI	A supply voltage to the analog circuit.			
4	IOVCC	A supply voltage to the logic circuit.			
5	/RESET	Reset input pin, Active "L".			
6	LEDPWM	Used for turning On/Off external LED backlight control.			
7	GND	Power ground.			
8	MIPI_D1P	MIPI-DSI data Lane 1 positive-end input pin			
9	MIPI_D1N	MIPI-DSI data Lane 1 negative-end input pin			
10	GND	Power ground			
11	MIPI_CLKP	MIPI-DSI clock Lane positive-end input pin			
12	MIPI_CLKN	MIPI-DSI clock Lane negative-end input pin			
13	GND	Power ground			
14	MIPI_D0P	MIPI-DSI data Lane 0 positive-end input pin			
15	MIPI_D0N	MIPI-DSI data Lane 0 negative-end input pin			
16	GND	Power ground			
17	TE	Tearing effect output pin to synchronize MCU to frame writing, activated by S/W command. When this pin is not activated, this pin is output low.			
18	GND	Power ground			
19	NC	NC.			
20	NC	NC.			

4.2 CTP Interface Description

Pin NO.	SYMBOL	DESCRIPTION				
1	VDD	Digital Power.				
2	RST	Reset pin. Active low to enter reset state.				
3	INT	Interruption signal.				
4	NC	NC.				
5	NC	NC.				
6	SCL	I2C_clock.				
7	SDA	I2C_data.				
8	GND	Power ground.				

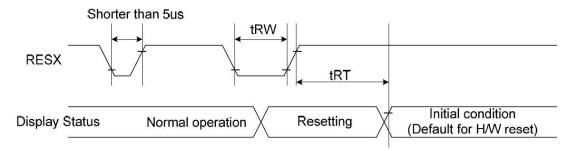
5. Absolute Maximum Ratings

Item	Symbol	Min.	Max.	Unit
Logic Supply Voltage	IOVCC	-0.3	4.6	٧
Analog Supply Voltage	VCI	-0.3	4.6	V
Input Voltage	Vin	-0.3	IOVCC+0.5	V
Operating Temperature	Тор	-20	70	°C
Storage Temperature	Тѕт	-30	80	°C
Storage Humidity	HD	20	90	%RH

6. DC Characteristics

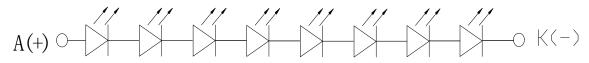
Item	Symbol	Min.	Тур.	Max.	Unit	Remark
Logic Supply Voltage	IOVCC	1.65	1.8/2.8	3.3	V	-
Analog Supply Voltage	VCI	2.5	2.8	3.3	V	-
Input High Voltage	V _{IH}	0.7IOVCC	-	IOVCC	V	Digital input pins
Input Low Voltage	V _{IL}	GND	-	0.3IOVCC	V	Digital input pins
Output High Voltage	V _{OH}	0.8IOVCC	-	IOVCC	V	Digital output pins
Output Low Voltage	V_{OL}	GND	-	0.2IOVCC	V	Digital output pins
I/O Leak Current	ILI	-1.0	-	1.0	uA	-

7. Reset Timing Characteristics



Signal	Symbol	Parameter	Min	Max	Unit
	tRW	Reset pulse duration	10		uS
RESX	tRT Reset cancel			5 (note 1,5)	mS
				120 (note 1,6,7)	mS

8. Backlight Charasterics



Item	Symbol	MIN	TYP	MAX	UNIT	Test Condition
Supply Voltage	Vf	23.2	26.4	28.0	V	If=20mA
Supply Current	If	-	20	30	mA	-
Luminous Intensity for LCM	-	250	300	-	Cd/m ²	lf=20mA
Uniformity for LCM	-	80	-	-	%	If=20mA
Life Time	-	20000	-	-	Hr	If=20mA
Backlight Color	White					

9. Optical Characteristics

The test of Optical specifications shall be measured in a dark room (ambient luminance 11ux and temperature = $25\pm2^{\circ}$ C) with the equipment of Luminance meter system (Goniometer system and TOPCON BM-5) and test unit shall be located at an approximate distance 50cm from the LCD surface at a viewing angle of θ and Φ equal to 0. The center of the measuring spot on the Display surface shall stay fixed.

The backlight should be operating for 30 minutes prior to measurement.

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
	θ_{L}		70	80	-	
Viewing Angle	θ_{R}	C.D. 10	70	80	-	daamaa
Viewing Angle	$\theta_{ m U}$	C.R. 10	70	80	-	degree
	θ_{D}		70	80	-	
Contrast Ratio	-	T = 25°C	650	800	-	-
Transmittance	T%(with polarizer + D65 light)	$T = 25^{\circ}C$	4.1	4.3	-	%
Pagnanga tima	Tr	$T = 25^{\circ}C$	2	5	40	ma
Response time	Tf	1 – 23 C	35		40	ms

Figure 1. The definition of Vth & Vsat

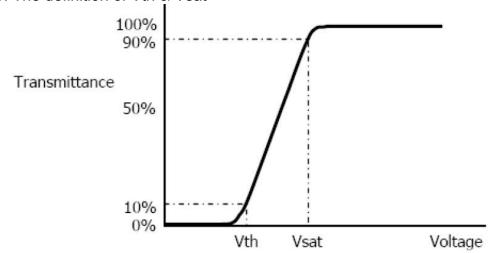


Figure 2. Measurement Set Up

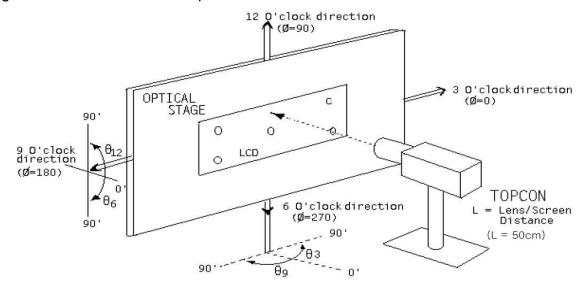
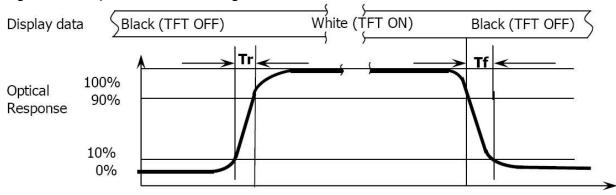


Figure 3. Response Time Testing



10. Reliability Test Conditions And Methods

NO.	TEST ITEMS	TEST CONDITION	INSPECTION AFTER TEST
1	High Temperature Storage	80℃±2℃×96Hours	
2	Low Temperature Storage	-30℃±2℃×96Hours	Inspection after 2~4hours
3	High Temperature Operating	70℃±2℃×96Hours	storage at room temperature,the samples
4	Low Temperature Operating	-20℃±2℃×96Hours	should be free from defects:
5	Temperature Cycle(Storage)	$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	1,Air bublle in the LCD. 2,Sealleak. 3,Non-display. 4,Missing segments. 5,Glass crack.
6	Damp Proof Test (Storage)	50℃±5℃×90%RH×96Hours	6,Current IDD is twice higher than initial value.
7	Vibration Test	Frequency:10Hz~55Hz~10Hz Amplitude:1.5M X,Y,Z direction for total 3hours (Packing Condition)	7,The surface shall be free from damage. 8,The electric charateristic
8	Drooping Test	Drop to the ground from 1M height one time every side of carton. (Packing Condition)	requirements shall be satisfied.
9	ESD Test	Voltage:±8KV,R:330Ω,C:150PF,Air Mode,10times	

REMARK:

- 1, The Test samples should be applied to only one test item.
- 2, Sample side for each test item is 5~10pcs.
- 3,For Damp Proof Test,Pure water(Resistance $> 10M\Omega$)should be used.
- 4,In case of malfunction defect caused by ESD damage,if it would be recovered to normal state after resetting,it would be judge as a good part.
- 5,EL evaluation should be excepted from reliability test with humidity and temperature:Some defects such as black spot/blemish can happen by natural chemical reaction with humidity and Fluorescence EL has.
- 6, Failure Judgment Criterion: Basic Specification Electrical Characteristic, Mechanical Characteristic, Optical Characteristic.

11. Inspection Standard

This standard apply to C-STN/TFT module

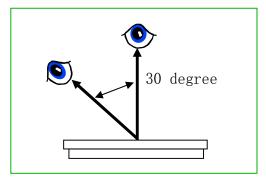
1. Spot check plan:

According to spot check level II, MIL-STD-105D Level II, the rank of accept or reject is below:

3A 级、2A 级: major non-conformance: AQL 0.25 minor non-conformance: AQL 0.4

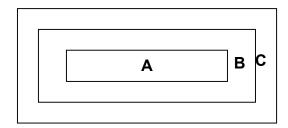
A 级: major non-conformance: AQL 0.65 minor non-conformance: AQL 1.

2. Inspection condition:



Under daylight lamp 20 \sim 40W, product distance inspector'eye 30cm,incline degree 30°.

3. LCD area define:



Area A: display area

Area B: VA area

Area C: out of VA area, not in sight after assemby

Remark :non-conformance at area C,but is OK that isn't influence raliability of product & assembly by customer.

4. Inspection standard
4.1 Major non-conformance

NO.	Item Inspection standard		Rate
4.1.1	Function non-confor mance	 No display, display abnormaly Miss line, short B/L no function or function abnormaly TP no function 	major
4.1.2	miss No matter miss what component		
4.1.3	Out of size	Module dimension out of spec	

4.2 Appearance non-conformance

NO.	Item	Inspection standard R							Rate	
4.2.1	Black or white spot (power on)	dot non-conformance define Φ $\Phi = \frac{(x+y)}{2}$								
		A grade								
		area		Most approve q'ty						
		size (mm))	Α	В		С			
		Ф≤0.10		ignore					Minor	
		0.10<Φ≤0.15		3						
		0.15<Φ≤0.20			2		ignore	:		
		0.20<Φ≤0.3		1]			
		0.3<Ф		0						
		Most approve 4 damages, dot to dot ≥10mm								
	Black or white line (power on)	A grade								
4.2.2		Size(mm)			Most approve			q'ty		
		L(length)	W(w	ridth)	Α		В	С		
		ignore	W≤0.03		ignore			ignore	Minor	
		L≤5.0	0.03< W≤0.05		2					
		L≤3.0	0.05< W≤0.07		1					
			0.07 <w< td=""><td colspan="2">Treat with dot non-conformance</td><td></td><td></td></w<>		Treat with dot non-conformance					
		Most approve 3 damages, line to line ≥10mm								
4.2.3	Polarizer position	polarizer attach meet drawing, disallow out of LCD. polarizer must cover display area (special require unless)						Minor		

4.2.4	LCD non-conf ormance	X ≤3 Crash d (ii) commonly sur X ≤2.0 (iii) crack Disallow exter	isallow extend to ITO rface scathe Y <frame edge<="" th=""/> <th>Z ignore</th> <th>Minor</th>	Z ignore	Minor
4.2.5	Contrast voltage warp	VOP/VIcd voltage	Minor		
4.2.6	color	Color & luminance	Minor		
4.2.7	Cross talk	Reference confirm	Minor		

12. Handling Precautions

12.1 Mounting method

The LCD panel of CH LCD module consists of two thin glass plates with polarizes which easily be damaged. And since the module in so constructed as to be fixed by utilizing fitting holes in the printed circuit board.

Extreme care should be needed when handling the LCD modules.

12.2 Caution of LCD handling and cleaning

When cleaning the display surface, Use soft cloth with solvent

[recommended below] and wipe lightly

- Isopropyl alcohol
- Ethyl alcohol

Do not wipe the display surface with dry or hard materials that will damage the polarizer surface.

Do not use the following solvent:

- Water
- Aromatics

Do not wipe ITO pad area with the dry or hard materials that will damage the ITO patterns Do not use the following solvent on the pad or prevent it from being contaminated:

- Soldering flux
- Chlorine (CI), Salfur (S)

If goods were sent without being sili8con coated on the pad, ITO patterns could be damaged due to the corrosion as time goes on.

If ITO corrosion happen by miss-handling or using some materials such as Chlorine (CI), Salfur (S) from customer, Responsibility is on customer.

12.3 Caution against static charge

The LCD module use C-MOS LSI drivers, so we recommended that you:

Connect any unused input terminal to Vdd or Vss, do not input any signals before power is turned on, and ground your body, work/assembly areas, assembly equipment to protect against static electricity.

12.4 packing

- Module employ LCD elements and must be treated as such.
- Avoid intense shock and falls from a height.
- To prevent modules from degradation, do not operate or store them exposed direct to sunshine or high temperature/humidity

12.5 Caution for operation

- It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage then the limit cause the shorter LCD life.
- An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided.
- Response time will be extremely delayed at lower temperature then the operating temperature range and on the other hand at higher temperature LCD's how dark color in them. However those phenomena do not mean malfunction or out of order with LCD's, which will come back in the specified operation temperature.
- If the display area is pushed hard during operation, some font will be abnormally displayed but it resumes normal condition after turning off once.
- A slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit.
 - Usage under the maximum operating temperature, 50%Rh or less is required.

12.6 storage

In the case of storing for a long period of time for instance, for years for the purpose or replacement use, the following ways are recommended.

- Storage in a polyethylene bag with the opening sealed so as not to enter fresh air outside in it . And with no desiccant.
- Placing in a dark place where neither exposure to direct sunlight nor light's keeping the storage temperature range.
- Storing with no touch on polarizer surface by the anything else.
 [It is recommended to store them as they have been contained in the inner container at the time of delivery from us

12.7 Safety

- It is recommendable to crash damaged or unnecessary LCD's into pieces and wash off liquid crystal by either of solvents such as acetone and ethanol, which should be burned up later.
- When any liquid leaked out of a damaged glass cell comes in contact with your hands, please wash it off well with soap and water

13. Precaution For Use

13.1

A limit sample should be provided by the both parties on an occasion when the both parties agreed its necessity. Judgment by a limit sample shall take effect after the limit sample has been established and confirmed by the both parties.

13.2

On the following occasions, the handing of problem should be decided through discussion and agreement between responsible of the both parties.

- When a question is arisen in this specification
- When a new problem is arisen which is not specified in this specifications
- When an inspection specifications change or operating condition change in customer is reported to CH LCD, and some problem is arisen in this specification due to the change
- When a new problem is arisen at the customer's operating set for sample evaluation in the customer site.

14. Packing Method

